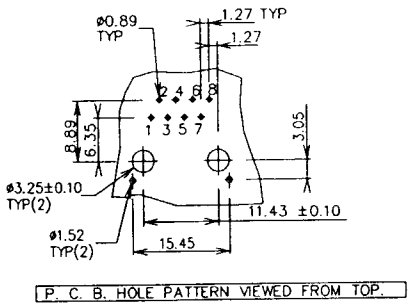
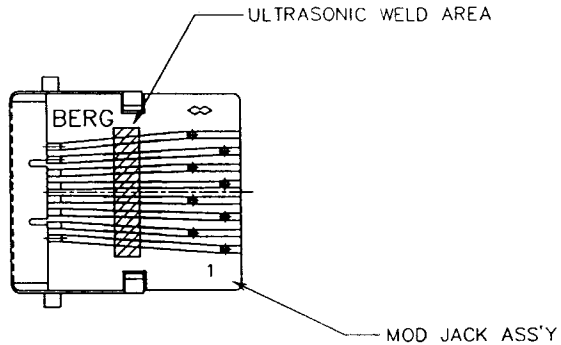
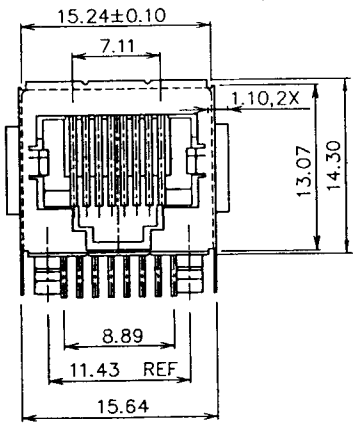


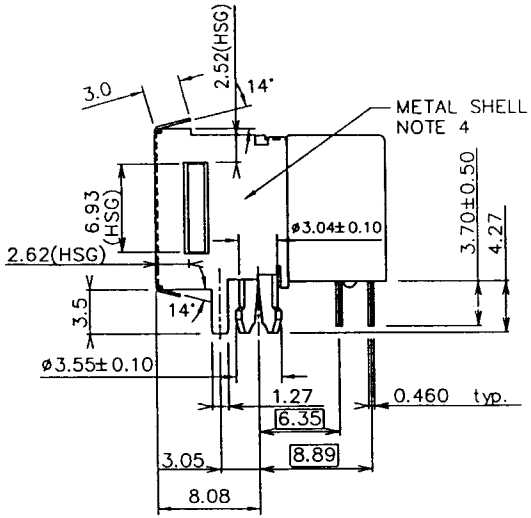
P. C. B. HOLE PATTERN VIEWED FROM TOP.



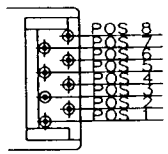
NOTES:

1. RECOMMENDED P.C.B THICKNESS 1.60 MM
2. HOUSING MAT'L: NYLON 66, 25% GLASS REINFORCED,
3. CONTACTS: PHOS BRONZE ALLOY UNS-C51000,
   ø 0.460 ROUND WIRE, PLATING SEE TABLE.
4. METAL SHELL MATERIAL:
   COPPER ALLOY, 0.20MM THICK.
   FINISH: TIN-LEAD 100 µ" THICK MIN.
5. PACKAGING PER GES-14-361, USING TUBE.

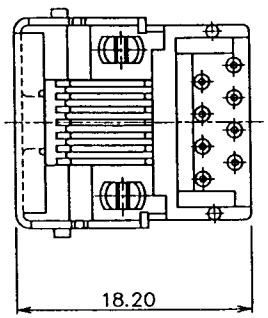




PLATING CODE X	PLATING
0	30µ" G.X.T.
1	15µ" GOLD.
2	20µ" GFPD.
3	30µ" GOLD.
5	50µ" GOLD.



POS. NO. CONFIGURATION



PRODUCT NO	NUMBER OF POS.	LOADED POSITION	MOD JACK ASS'Y
61362-X88	8	ALL POS.	94908-X88
61362-X86		2,3,4,5,6,7	94908-X86
61362-X84		3,4,5,6	94908-X84
61362-X84A		1,2,3,6	94908-X84A

rev.	ecn no.	dr	date
A	T60184	C L	05/02/96
B	V70385	C L	04/14/97

mat'l code

tolerance unless otherwise specified

linear .0 ± 0.25; .00 ± 0.13; .000± 0.05

angles ± 2°

projection

CUSTOMER COPY

dr	C L FENG	04/10/96
engr	TONY CHIEN	04/10/96
chr	TONY CHIEN	04/10/96
appd	JENN TSAO	04/10/96

unit mm/inch

scale 2.5/1

BERG ELECTRONICS

title MODIFIED LOW PROFILE PCB III 8-POS SHIELDED MOD JACK, CUST SPCL.

product family

code TWN

size A3

dwg no. 61362

sheet 1 OF 1

sheet	revision	B
index	sheet	1

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